

RoHS COMPLIANT

Vishay Siliconix

N-Channel 240-V (D-S) MOSFET

PRODUCT SUMMARY				
V _{DS} (V)	R_{DS(on)} (Ω)	I _D (A)	Q _g (Typ.)	
	2.9 at V _{GS} = 10 V	1.52		
240	2.95 at V _{GS} = 4.5 V	1.5	2.54 nC	
	3.5 at V _{GS} = 2.5 V	1.44		

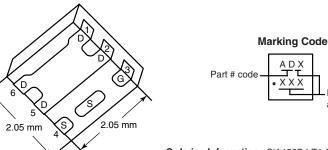
PowerPAK SC-70-6L-Single

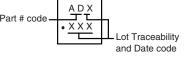
FEATURES

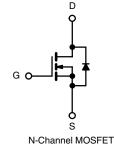
- · Halogen-free
- TrenchFET[®] Power MOSFET
- New Thermally Enhanced PowerPAK® SC-70 Package
- Small Footprint Area
- Low On-Resistance

APPLICATIONS

Boost Converter for Portable Devices







Ordering Information: SiA450DJ-T1-GE3 (Lead (Pb)-free and Halogen-free)

ABSOLUTE MAXIMUM RATINGS T _A = 25 °C, unles Parameter		Symbol	Limit	Unit	
Drain-Source Voltage	V _{DS}	240	V		
Gate-Source Voltage		V _{GS}			± 20
	T _C = 25 °C		1.52		
Continuous Drain Current ($T_1 = 150 \ ^{\circ}C$)	T _C = 70 °C	I _D	1.21		
	T _A = 25 °C	D	0.70 ^{a, b}		
	T _A = 70 °C		0.56 ^{a, b}	A	
Pulsed Drain Current		I _{DM}	1.5	7	
Continuous Source-Drain Diode Current	T _C = 25 °C	I _S	12.8		
Continuous Source-Drain Diode Current	T _A = 25 °C	'S	2.74 ^{a, b}		
	T _C = 25 °C		15		
Maximum Power Dissipation	T _C = 70 °C	PD	9.8	w	
	T _A = 25 °C	' D	3.3 ^{a, b}	~~~~	
	T _A = 70 °C		2.1 ^{a, b}	7	
Operating Junction and Storage Temperature R	Т _Ј , Т _{stg}	- 55 to 150	°C		
Soldering Recommendations (Peak Temperature) ^{c, d}			260		

THERMAL RESISTANCE RATINGS						
Parameter		Symbol	Typical	Maximum	Unit	
Maximum Junction-to-Ambient ^{a, e}	t ≤ 5 s	R _{thJA}	30	38	°C/W	
Maximum Junction-to-Case (Drain)	Steady State	R _{thJC}	6.5	8.1	0/11	

Notes:

a. Surface Mounted on 1" x 1" FR4 board.

b. t = 5 s.

c. See Solder Profile (http://www.vishay.com/ppg?73257). The PowerPAK SC-70 is a leadless package. The end of the lead terminal is exposed copper (not plated) as a result of the singulation process in manufacturing. A solder fillet at the exposed copper tip cannot be guaranteed and is not required to ensure adequate bottom side solder interconnection.

d. Rework Conditions: manual soldering with a soldering iron is not recommended for leadless components.

e. Maximum under Steady State conditions is 80 °C/W.

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SiA450DJ

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SPECIFICATIONS $T_J = 25 \ ^{\circ}C$		erwise noted					
Parameter	Symbol	Test Conditions	Min.	Тур.	Max.	Unit	
Static				T	T	•	
Drain-Source Breakdown Voltage	V _{DS}	$V_{GS} = 0 V, I_{D} = -250 \mu A$	240			V	
V _{DS} Temperature Coefficient	$\Delta V_{DS}/T_{J}$	I _D = - 250 μA		247.4		mV/°C	
V _{GS(th)} Temperature Coefficient	$\Delta V_{GS(th)}/T_J$			4.22			
Gate-Source Threshold Voltage	V _{GS(th)}	$V_{DS} = V_{GS}, I_D = -250 \ \mu A$ $V_{DS} = 0 \ V, V_{GS} = \pm 20 \ V$	0.8		2.4	V	
Gate-Source Leakage	Source Leakage I _{GSS}				± 100	nA	
Zero Gate Voltage Drain Current	I _{DSS}	$V_{DS} = 240 \text{ V}, V_{GS} = 0 \text{ V}$			- 1	μΑ	
Zelo Gale Vollage Dialit Guitent	·D88	V_{DS} = 240 V, V_{GS} = 0 V, T_{J} = 55 °C			- 10		
On-State Drain Current ^a	I _{D(on)}	$V_{DS} \le 10$ V, $V_{GS} = 10$ V	1.5			A	
		$V_{GS} = 10 \text{ V}, \text{ I}_{D} = 0.70 \text{ A}$		2.4	2.9	Ω	
Drain-Source On-State Resistance ^a	R _{DS(on)}	$V_{GS} = 4.5 \text{ V}, \text{ I}_{D} = 0.65 \text{ A}$		2.46	2.95		
		$V_{GS} = 2.5 \text{ V}, \text{ I}_{D} = 0.50 \text{ A}$		2.85	3.5		
Forward Transconductance ^a	9 _{fs}	$V_{DS} = 120 \text{ V}, \text{ I}_{D} = 0.70 \text{ A}$		3.14		S	
Dynamic ^b							
Input Capacitance	C _{iss}			167		pF	
Output Capacitance	C _{oss}	$V_{DS} = 120 \text{ V}, V_{GS} = 0 \text{ V}, \text{ f} = 1 \text{ MHz}$		10			
Reverse Transfer Capacitance	C _{rss}			3.4			
		V_{DS} = 120 V, V_{GS} = 10 V, I_{D} = 0.70 A		4.69	7.035	nC	
Total Gate Charge	Q _g Q _{gs}	$V_{DS} = 120 \text{ V}, \text{ V}_{GS} = 4.5 \text{ V}, \text{ I}_{D} = 0.70 \text{ A}$		2.54	3.81		
Gate-Source Charge				0.58			
Gate-Drain Charge	Q _{gd}			1.14			
Gate Resistance	Rg	f = 1 MHz		2		Ω	
Turn-On Delay Time	t _{d(on)}			13.7	21		
Rise Time	t _r	$V_{DD} = 120 \text{ V}, \text{ R}_{L} = 200 \Omega$		22	33	- ns	
Turn-Off Delay Time	t _{d(off)}	$I_D \cong 0.60$ A, V_{GEN} = 4.5 V, R_g = 1 Ω		23	35		
Fall Time	t _f			19	29		
Turn-On Delay Time	t _{d(on)}			4.5	6.75		
Rise Time	t _r	V_{DD} = 120 V, R_{L} = 184 Ω		11	16.5		
Turn-Off Delay Time	t _{d(off)}	$I_D \cong 0.70$ A, $V_{GEN} = 10$ V, $R_g = 1$ Ω		12	18		
Fall Time	t _f	-		15	22.5		
Drain-Source Body Diode Characterist	ics						
Continuous Source-Drain Diode Current	۱ _S	T _C = 25 °C			2.7		
Pulse Diode Forward Current	I _{SM}				12.8	A	
Body Diode Voltage	V _{SD}	$I_{S} = 0.5 \text{ A}, V_{GS} = 0 \text{ V}$		0.8	1.2	V	
Body Diode Reverse Recovery Time	t _{rr}			50.2	75.3	ns	
Body Diode Reverse Recovery Charge	Q _{rr}			68	102	nC	
Reverse Recovery Fall Time	t _a			25			
Reverse Recovery Rise Time	t _b			25.2		ns	

Notes:

a. Pulse test; pulse width \leq 300 $\mu s,$ duty cycle \leq 2 %.

b. Guaranteed by design, not subject to production testing.

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

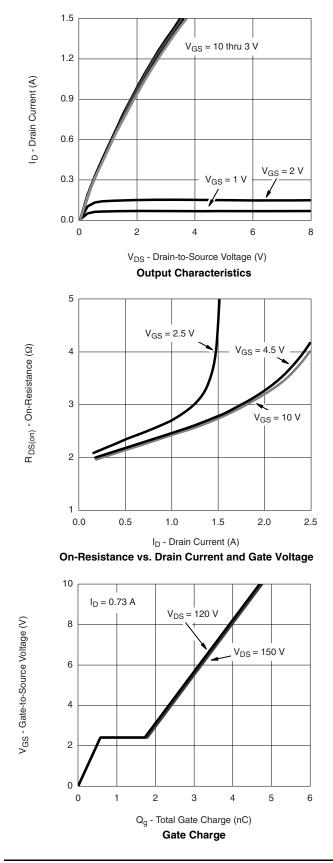


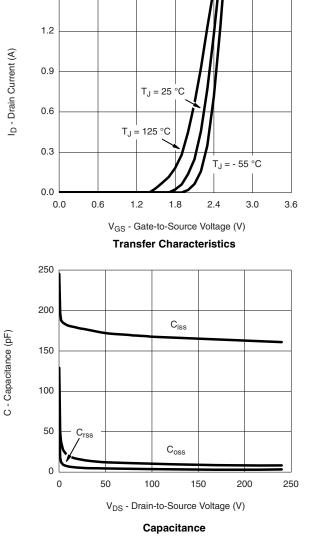
1.5

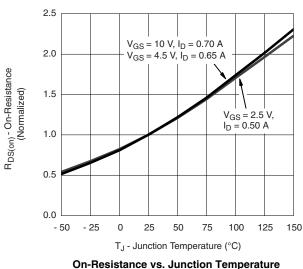
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TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted







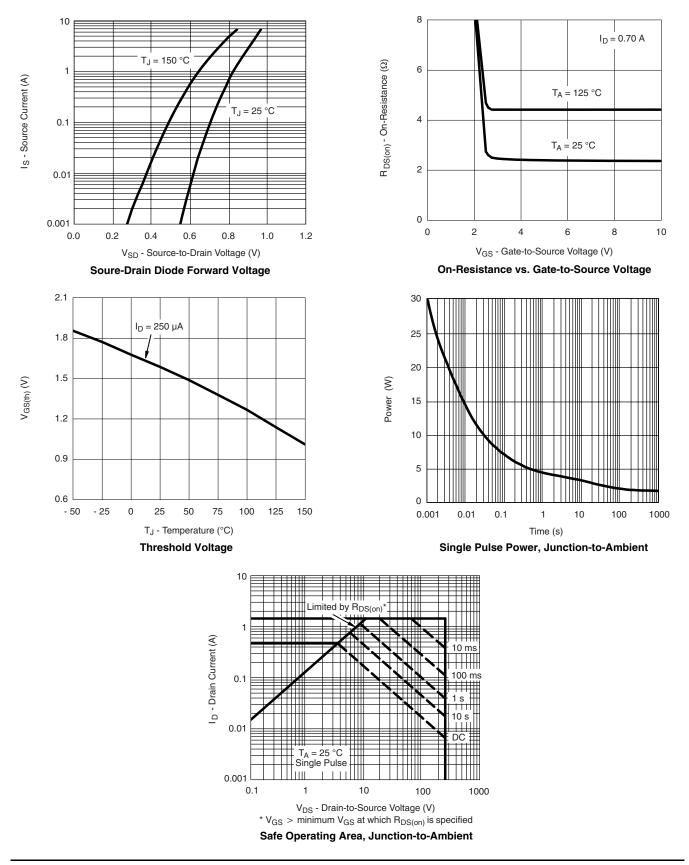
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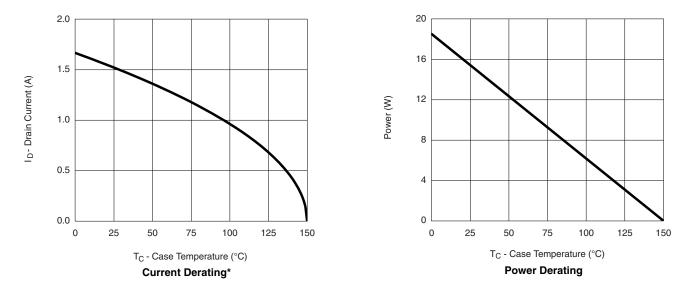
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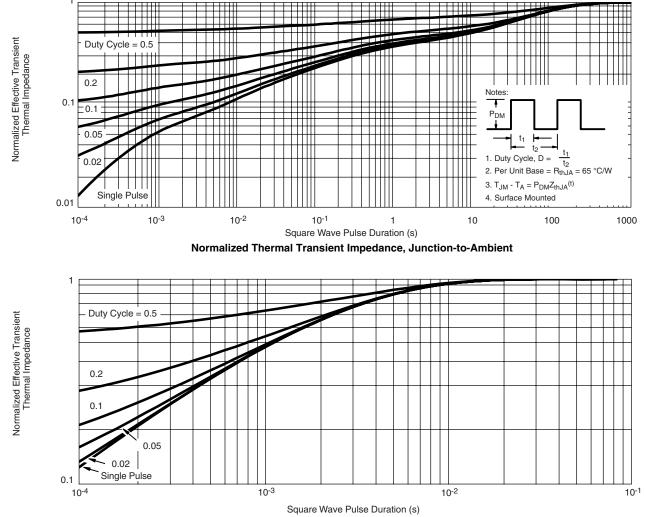
* The power dissipation P_D is based on $T_{J(max)}$ = 150 °C, using junction-to-case thermal resistance, and is more useful in settling the upper dissipation limit for cases where additional heatsinking is used. It is used to determine the current rating, when this rating falls below the package limit.

SiA450DJ

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TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted



Normalized Thermal Transient Impedance, Junction-to-Case

Vishay Siliconix maintains worldwide manufacturing capability. Products may be manufactured at one of several qualified locations. Reliability data for Silicon Technology and Package Reliability represent a composite of all qualified locations. For related documents such as package/tape drawings, part marking, and reliability data, see http://www.vishay.com/ppg?73603.

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